

## MiniSKiiP<sup>®</sup> 2

### H-bridge inverter

### SKiiP 26GH12T4V11

#### Features\*

- Trench 4 IGBTs
- Robust and soft switching freewheeling diodes in CAL technology
- Highly reliable spring contacts for
- electrical connectionsUL recognized: File no. E63532

### Typical Applications

Single phase inverter

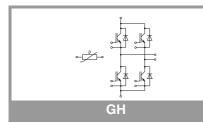
#### Remarks

- Case temperature limited to  $T_C=125^{\circ}C$  max.;  $T_C = T_S$  (valid for baseplateless modules)
- Product reliability results valid for  $T_j \le 150^{\circ}C$  (recommended  $T_{op} = -40... + 150^{\circ}C$ )

**Absolute Maximum Ratings** Symbol Conditions Values Unit **Inverter - IGBT** V T<sub>i</sub> = 25 °C 1200  $V_{CES}$ T<sub>s</sub> = 25 °C 90 А lc T<sub>i</sub> = 175 °C T<sub>s</sub> = 70 °C 73 А I<sub>Cnom</sub> 70 А 210 Α **I**CRM -20 ... 20 V VGES V<sub>CC</sub> = 800 V  $V_{GE} \le 15 \text{ V}$ T<sub>i</sub> = 150 °C 10 μs t<sub>psc</sub>  $V_{CES} \le 1200 \text{ V}$ °C T<sub>i</sub> -40 ... 175 **Inverse - Diode** T<sub>s</sub> = 25 °C 83  $I_{F}$ А T<sub>i</sub> = 175 °C T<sub>s</sub> = 70 °C 66 А **I**FRM 225 А 10 ms, sin 180°,  $T_j = 150 \ ^{\circ}C$ 430 А I<sub>FSM</sub> -40 ... 175 °C Tj Module T<sub>terminal</sub> = 80 °C, 20 A per spring 100 А It(RMS) module without TIM -40 ... 125 °C T<sub>stg</sub>  $V_{\text{isol}}$ AC sinus 50 Hz, t = 1 min 2500 ٧

### Characteristics

Symbol	Conditions		min.	typ.	max.	Unit			
Inverter -	IGBT								
V <sub>CE(sat)</sub>	I <sub>C</sub> = 70 A V <sub>GE</sub> = 15 V chiplevel	T <sub>j</sub> = 25 °C		1.85	2.10	V			
		T <sub>j</sub> = 150 °C		2.25	2.45	V			
V <sub>CE0</sub>	chiplevel	T <sub>j</sub> = 25 °C		0.80	0.90	V			
	chiplevel	T <sub>j</sub> = 150 °C		0.70	0.80	V			
r <sub>CE</sub>	V <sub>GE</sub> = 15 V chiplevel	T <sub>j</sub> = 25 °C		15	17	mΩ			
		T <sub>j</sub> = 150 °C		22	24	mΩ			
V <sub>GE(th)</sub>	$V_{GE} = V_{CE}, I_C = 2 \text{ m}$	A	5	5.8	6.5	V			
I <sub>CES</sub>	V <sub>GE</sub> = 0 V V <sub>CE</sub> = 1200 V	T <sub>j</sub> = 25 °C			1	mA			
						mA			
Cies	V <sub>CE</sub> = 25 V V <sub>GE</sub> = 0 V	f = 1 MHz		3.90		nF			
C <sub>oes</sub>		f = 1 MHz		0.31		nF			
Cres	VGE - V V	f = 1 MHz		0.23		nF			
Q <sub>G</sub>	V <sub>GE</sub> = - 8 V+ 15 V		400		nC				
R <sub>Gint</sub>	T <sub>j</sub> = 25 °C		0		Ω				
t <sub>d(on)</sub>	V <sub>CC</sub> = 600 V	T <sub>j</sub> = 150 °C		26		ns			
t <sub>r</sub>	$\label{eq:Gamma} \begin{array}{l} I_{C} = 75 \text{ A} \\ R_{G \text{ on}} = 9.1 \ \Omega \\ R_{G \text{ off}} = 9.1 \ \Omega \\ \text{d}i/\text{d}_{\text{on}} = 1820 \ \text{A}/\mu\text{s} \\ \text{d}i/\text{d}_{\text{off}} = 900 \ \text{A}/\mu\text{s} \end{array}$	T <sub>j</sub> = 150 °C		36		ns			
Eon		T <sub>j</sub> = 150 °C	9.5 320		mJ				
t <sub>d(off)</sub>		T <sub>j</sub> = 150 °C				ns			
t <sub>f</sub>		T <sub>j</sub> = 150 °C		175		ns			
E <sub>off</sub>		T <sub>j</sub> = 150 °C	7.1			mJ			
R <sub>th(j-s)</sub>	per IGBT, λ <sub>paste</sub> =0.8	3 W/(K*m)		0.55		K/W			





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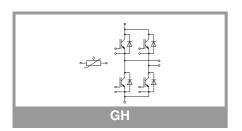
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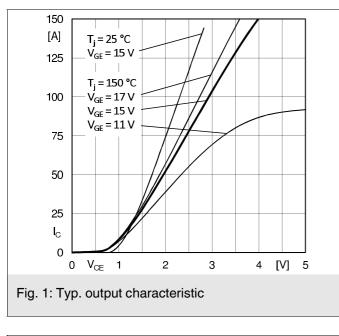
Single phase inverter

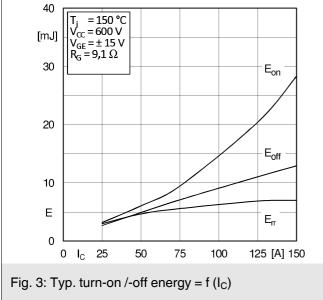
### Remarks

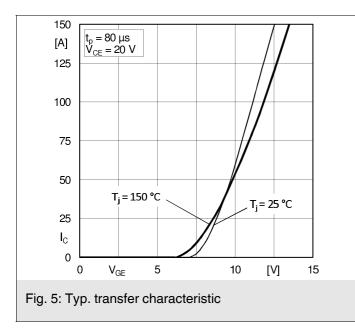
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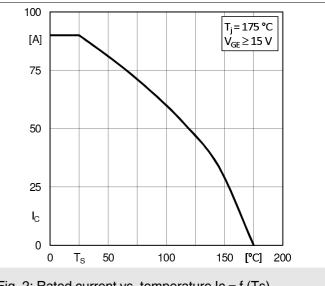
Characte	ristics					
Symbol	Conditions		min.	typ.	max.	Unit
Inverse -	Diode					
$V_F = V_{EC}$	$I_F = 75 A$ $V_{GE} = 0 V$ chiplevel	T <sub>j</sub> = 25 °C		2.17	2.49	V
		T <sub>j</sub> = 150 °C		2.11	2.42	V
V <sub>F0</sub>	chiplevel	T <sub>j</sub> = 25 °C		1.30	1.50	V
	chiplevel	T <sub>j</sub> = 150 °C		0.90	1.10	V
r <sub>F</sub>	chiplevel	T <sub>j</sub> = 25 °C		12	13	mΩ
	chipievei	T <sub>j</sub> = 150 °C		16	18	mΩ
I <sub>RRM</sub>	I <sub>F</sub> = 75 A di/dt <sub>off</sub> = 2120 A/μs - V <sub>GE</sub> = -15 V	T <sub>j</sub> = 150 °C		80		Α
Q <sub>rr</sub>		T <sub>j</sub> = 150 °C		13.3		μC
E <sub>rr</sub>	$V_{CC} = 600 V$	T <sub>j</sub> = 150 °C		5.6		mJ
R <sub>th(j-s)</sub>	per Diode, $\lambda_{paste}=0$ .		0.75		K/W	
Module						
L <sub>CE</sub>				-		nH
Ms	to heat sink		2		2.5	Nm
w				55		g
Temperat	ure Sensor					
R <sub>100</sub>	T <sub>r</sub> =100°C (R <sub>25</sub> =100		1670 ± 3%		Ω	
B <sub>100/125</sub>	R(T)=R <sub>100</sub> exp[B <sub>100/</sub>		3550 ± 2%		к	

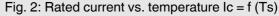


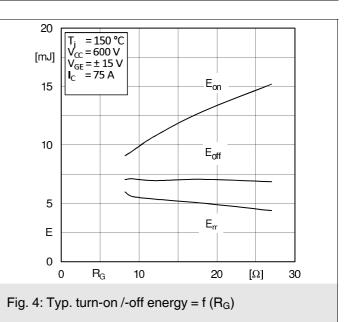


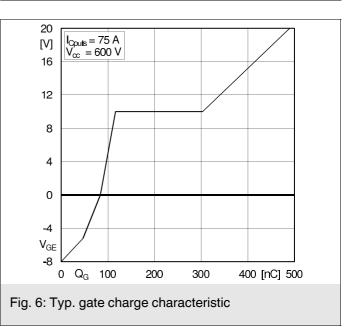


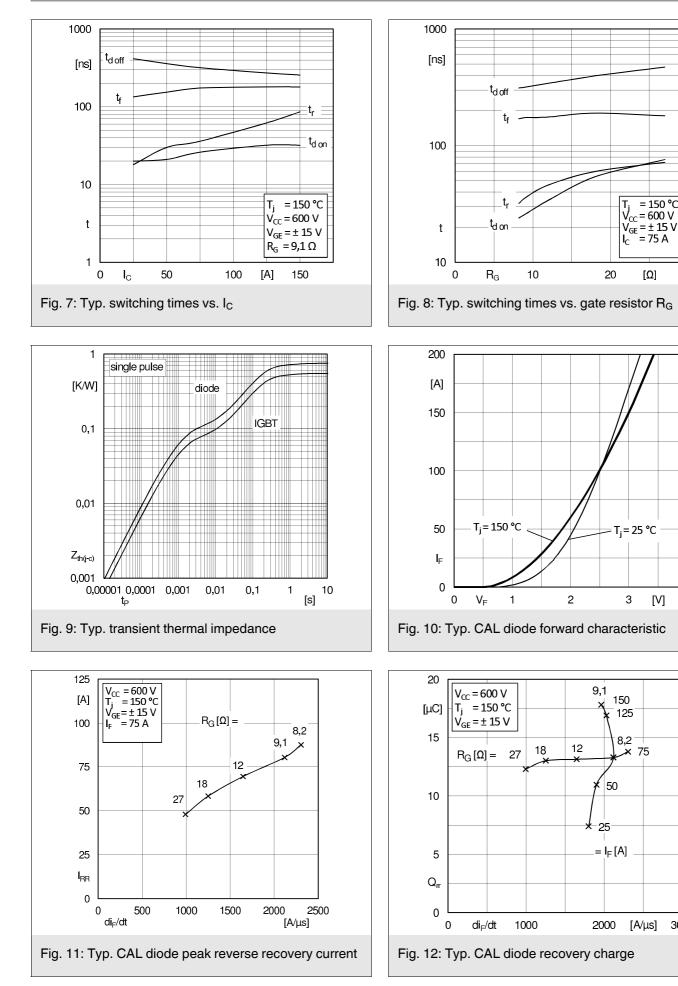












3000

= 150 °C

= 75 A

[Ω]

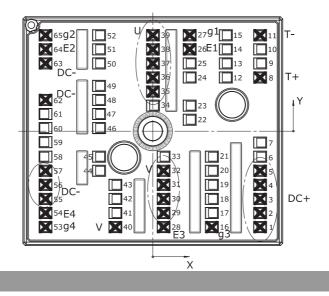
[V]

4

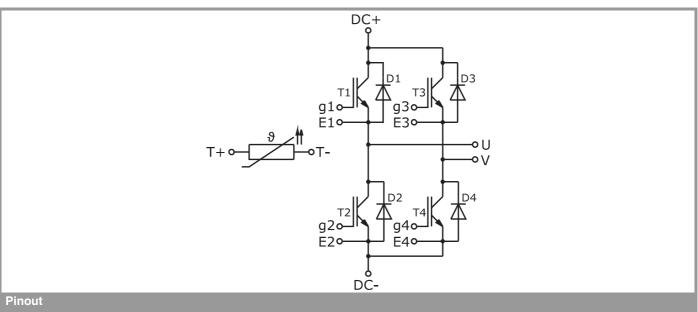
30

Pin out											
Pin	X	Y	Function	Pin	X	Y	Function	Pin	X	Y	Functior
1	24,38	-21,80	DC+	23	8,38	5,80		45	-12,23	-5,80	
2	24,38	-18,60	DC+	24	8,38	12,20		46	-12,23	0,70	
3	24,38	-15,40	DC+	25	8,38	15,40		47	-12,23		
4	24,38	-12,20	DC+	26	8,38		E1	48	-12,23	7,10	
5	24,38	-9,00	DC+	27	8,38	21,80	g1	49	-12,23		
6	24,38	-5,80		28	2,46	-21,80	E3	50	-12,23	15,40	
7	24,38	-2,60		29	2,46	-18,60	V	51	-12,23		
8	24,38	12,20	T+	30	2,46		V	52	-12,23		
9	24,38	15,40		31	2,46		V	53	-24,38		
10	24,38	18,60		32	2,46	-9,00	V	54	-24,38	-18,60	E4
11	24,38	21,80	Т-	33	2,46			55	-24,38	-15,40	DC-
12	16,58	12,20		34	0,03	5,80		56	-24,38		DC-
13	16,58	15,40		35	0,03	9,00	U	57	-24,38		
14	16,58	18,60		36	0,03	12,20	U	58	-24,38		
15	16,58	21,80		37	0,03	15,40	U	59	-24,38		
16	13,42	-21,80	g3	38	0,03	18,60	U	60	-24,38	0,70	
17	13,42	-18,60		39	0,03	21,80	U	61	-24,38	3,90	
18	13,42	-15,40		40	-8,51	-21,80	V	62	-24,38		DC-
19	13,42	-12,20		41	-8,51	-18,60		63	-24,38	15,40	DC-
20	13,42	-9,00		42	-8,51	-15,40		64	-24,38		
21	13,42	-5,80		43	-8,51	-12,20		65	-24,38	21,80	g2
22	8,38	2,60		44	-12,23	-9,00					

all values in mm



**Pinout and Dimensions** 



This is an electrostatic discharge sensitive device (ESDS) due to international standard IEC 61340.

#### **\*IMPORTANT INFORMATION AND WARNINGS**

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